MOTOROLA
SEMICONDUCTOR
TECHNICAL DATA

BUV20

SWITCHMODE▲ SERIES
NPN SILICON POWER TRANSISTOR

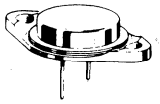
. . . designed for high speed, high current, high power applications.

- High DC current gain:
  HFE min. = 20 at Ic = 25 A
  = 10 at Ic = 50 A
- Low $V_{CE(sat)}$:
  $V_{CE(sat)}$ max. = 0.6 V at Ic = 25 A
  = 1.2 V at Ic = 50 A
- Very fast switching times:
  T_F = 0.25 μs at Ic = 50 A

50 AMPERES

NPN SILICON POWER METAL TRANSISTOR

125 VOLTS
250 WATTS

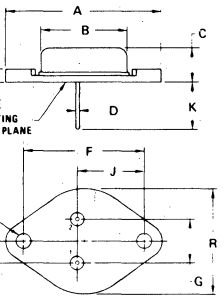


MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CEO(sus)}$	125	Vdc
Collector-Base Voltage	V_{CBO}	160	Vdc
Emitter-Base Voltage	V_{EBO}	7	Vdc
Collector-Emitter Voltage (V_{BE} = −1.5 V)	V_{CEX}	160	Vdc
Collector-Emitter Voltage (R_{BE} = 100Ω)	V_{CER}	150	Vdc
Collector-Current — continuous — peak (pw ≤ 10 ms)	I_C I_{CM}	50 60	Adc Apk
Base-Current continuous	I_B	10	Adc
Total Power Dissipation @ T_C = 25°C	P_D	250	Watts
Operating and Storage Junction Temperature Range	T_J, T_{stg}	−65 to 200	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max.	Unit
Thermal Resistance, Junction to Case	θ_{JC}	0.7	°C/W

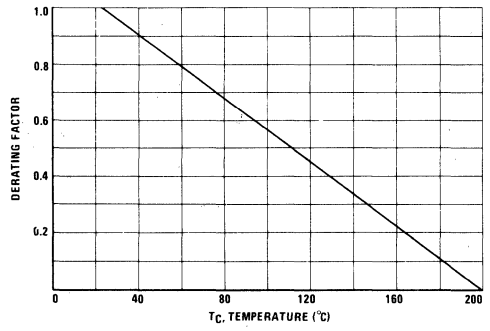


STYLE 1:
PIN 1. BASE
2. EMITTER
CASE. COLLECTOR

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	38.35	39.37	1.510	1.550
B	19.30	21.08	0.760	0.830
C	6.35	7.62	0.250	0.300
D	1.45	1.60	0.057	0.063
E	–	3.43	–	0.135
F	29.90	30.40	1.177	1.197
G	10.67	11.18	0.420	0.440
H	5.21	5.72	0.205	0.225
J	16.64	17.15	0.655	0.675
K	11.18	12.19	0.440	0.480
Q	3.84	4.09	0.151	0.161
R	24.89	26.67	0.980	1.050

CASE 197-01
MODIFIED TO 3

FIGURE 1 – POWER DERATING



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ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

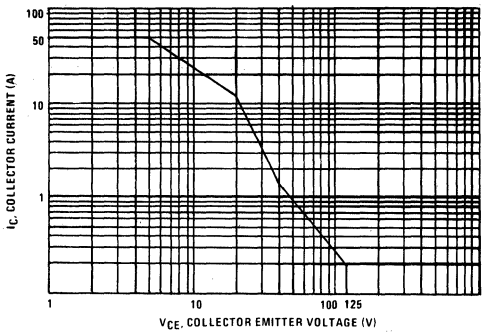
Characteristic	Symbol	Min.	Max.	Unit
OFF CHARACTERISTICS[1]				
Collector-Emitter Sustaining Voltage (I_C = 200 mA, I_B = 0, L = 25 mH)	$V_{CEO(sus)}$	125		Vdc
Collector Cutoff Current at Reverse Biais: (V_{CE} = 140 V, V_{BE} = −1.5 V) (V_{CE} = 140 V, V_{BE} = −1.5 V, T_C = 125°C)	I_{CEX}		3.0 12	mAdc
Collector-Emitter Cutoff Current (V_{CE} = 100 V)	I_{CEO}		3.0	mAdc
Emitter-Base Reverse Voltage (I_E = 50 mA)	V_{EBO}	7		V
Emitter-Cutoff Current (V_{EB} = 5 V)	I_{EBO}		1.0	mAdc
SECOND BREAKDOWN				
Second Breakdown Collector Current with base forward biased (V_{CE} = 20 V, t = 1 s) (V_{CE} = 40 V, t = 1 s)	$I_{S/b}$	12 1.5		Adc
ON CHARACTERISTICS[1]				
DC Current Gain (I_C = 25 A, V_{CE} = 2 V) (I_C = 50 A, V_{CE} = 4 V)	h_{FE}	20 10	60	
Collector-Emitter Saturation Voltage (I_C = 25 A, I_B = 2.5 A) (I_C = 50 A, I_B = 5 A)	$V_{CE(sat)}$		0.6 1.2	Vdc
Base-Emitter Saturation Voltage (I_C = 50 A, I_B = 5 A)	$V_{BE(sat)}$		2.0	Vdc
DYNAMIC CHARACTERISTICS				
Current Gain – Bandwidth Product (V_{CE} = 15 V, I_C = 2 A, f = 4 MHz)	f_T	8.0		MHz

SWITCHING CHARACTERISTICS (Resistive Load)

Turn on Time	I_C = 50 A, I_{B1} = I_{B2} = 5 A, (V_{CC} = 30 V, RC = 0.6 Ω)	t_{on}		1.5	μs
Storage Time		t_s		1.2	
Fall Time		t_f		0.25	

[1] Pulse Test: Pulse Width ≤300 μs, Duty Cycle ≤2%.

FIGURE 2 – ACTIVE REGION SAFE OPERATING AREA



There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C-V_{CE} limits of the transistor that must be observed for reliable operation i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of figure 2 is based on T_C = 25 C; $T_{J(pk)}$ is variable depending on power level. Second breakdown limitations do not derate the same as thermal limitations.

At high case temperatures, thermal limitations will reduce the power that can handled to values less than the limitations imposed by second breakdown. (See AN415A)

FIGURE 3 – "ON" VOLTAGES

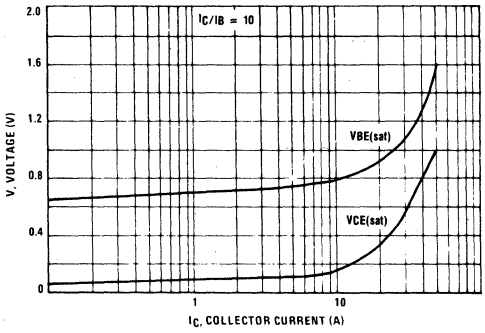


FIGURE 4 – DC CURRENT GAIN

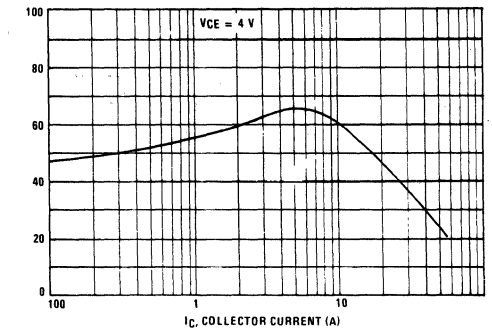


FIGURE 5 – RESISTIVE SWITCHING PERFORMANCE

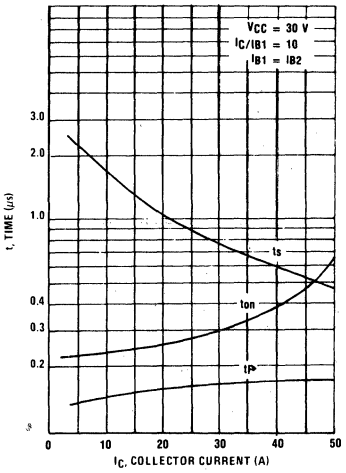
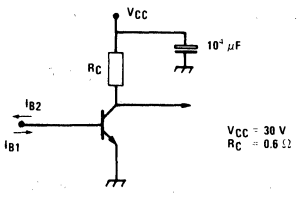


FIGURE 6 – SWITCHING TIMES TEST CIRCUIT



R_C – Non inductive resistance

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